# **Digital FET, N-Channel**

# **FDV303N**

#### **General Description**

These N-Channel enhancement mode field effect transistors are produced using ON Semiconductor's proprietary, high cell density, DMOS technology. This very high density process is tailored to minimize on-state resistance at low gate drive conditions. This device is designed especially for application in battery circuits using either one lithium or three cadmium or NMH cells. It can be used as an inverter or for high-efficiency miniature discrete DC/DC conversion in compact portable electronic devices like cellular phones and pagers. This device has excellent on-state resistance even at gate drive voltages as low as 2.5 V.

#### Features

- 25 V, 0.68 A Continuous, 2 A Peak
  - $R_{DS(ON)} = 0.45 \Omega @ V_{GS} = 4.5 V$
  - $R_{DS(ON)} = 0.6 \Omega @ V_{GS} = 2.7 V$
- Very Low Level Gate Drive Requirements Allowing Direct Operation in 3 V Circuits,  $V_{GS(th)} < 1 V$
- Gate–Source Zener for ESD Ruggedness, > 6 kV Human Body Model
- Compact Industry Standard SOT-23 Surface Mount Package
- This Device is Pb-Free, Halogen Free/BFR Free and is RoHS Compliant

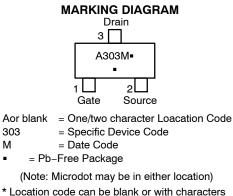


# **ON Semiconductor®**

www.onsemi.com



SOT-23 (TO-236) CASE 318-08 STYLE 21

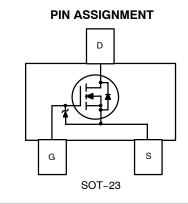


indicating manufacturing location

303

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\* Date Code orientation and overbar may vary depending upon manufacturing location.



#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet

#### **MOSFET MAXIMUM RATINGS** $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	FDV303N	Units
V <sub>DSS</sub>	Drain-Source Voltage, Power Supply Voltage	25	V
V <sub>GSS</sub>	Gate-Source Voltage, V <sub>IN</sub>	8	V
۱ <sub>D</sub>	Drain/Output Current – Continuous – Pulsed	0.68 2	A
PD	Maximum Power Dissipation	0.35	W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	–55 to 150	°C
ESD	Electrostatic Discharge Rating MIL-STD-883D Human Body Model (100 pf / 1500 $\Omega$ )	6.0	kV

#### THERMAL CHARACTERISTICS

Symbol	Parameter	Ratings	Units
$R_{\thetaJA}$	Thermal Resistance, Junction-to-Ambient	357	°C/W

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
FDV303N	SOT-23 Case 318-08	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

#### **ELECTRICAL CHARACTERISTICS** $T_J = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Conditions	Min	Тур	Max	Units
OFF CH/	ARACTERISTICS	-				
<b>BV</b> <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_D = 250 \mu A$	25			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temp. Coefficient	$I_D = 250 \ \mu$ A, Referenced to $25^{\circ}$ C		26		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA
		$T_J = 55^{\circ}C$			10	μA
I <sub>GSS</sub>	Gate – Body Leakage Current	V <sub>GS</sub> = 8 V, V <sub>DS</sub> = 0 V			100	nA
ON CHA	RACTERISTICS (Note 1)					
ΔV <sub>GS(th)</sub> / ΔT <sub>J</sub>	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		-2.6		mV/°C
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	0.65	0.8	1	V
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$		0.33	0.45	Ω
		T <sub>J</sub> =125°C		0.52	0.8	1
		$V_{GS} = 2.7 \text{ V}, \text{ I}_{D} = 0.2 \text{ A}$		0.44	0.6	1
I <sub>D(ON)</sub>	On-State Drain Current	$V_{GS} = 2.7 \text{ V}, V_{DS} = 5 \text{ V}$	0.5			А
9FS	Forward Transconductance	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 0.5 A		1.45		S
DYNAMI	C CHARACTERISTICS					
C <sub>iss</sub>	Input Capacitance	$V_{DS}$ = 10 V, $V_{GS}$ = 0 V, f = 1.0 MHz		50		pF
C <sub>oss</sub>	Output Capacitance			28		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			9		pF
SWITCH	ING CHARACTERISTICS (Note 1)					
t <sub>D(on)</sub>	Turn – On Delay Time	$V_{DD}$ = 6 V, $I_{D}$ = 0.5 A, $V_{GS}$ = 4.5 V, $R_{GEN}$ = 50 $\Omega$		3	6	ns
tr	Turn – On Rise Time	7		8.5	18	ns

D(on)	Turri – On Delay Time	$v_{\rm DD} = 0.07$ , $v_{\rm GS} = 4.0$ , $v_{\rm GEN} = 00.22$	5	0	115
t <sub>r</sub>	Turn – On Rise Time		8.5	18	ns
t <sub>D(off)</sub>	Turn – Off Delay Time		17	30	ns
t <sub>f</sub>	Turn – Off Fall Time		13	25	ns
Qg	Total Gate Charge	$V_{DS}$ = 5 V, I <sub>D</sub> = 0.5 A, $V_{GS}$ = 4.5 V	1.64	2.3	nC
Q <sub>gs</sub>	Gate-Source Charge		0.38		nC
Q <sub>gd</sub>	Gate-Drain Charge		0.45		nC

## DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current			0.3	А
$V_{SD}$	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 0.5 A (Note 1)	0.83	1.2	V

1. Pulse Test: Pulse Width < 300  $\mu$ s, Duty Cycle < 2.0%.

## **TYPICAL CHARACTERISTICS**

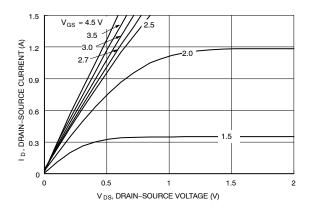


Figure 1. On-Region Characteristics

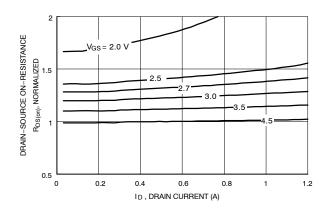


Figure 2. On–Resistance Variation with Drain Current and Gate Voltage

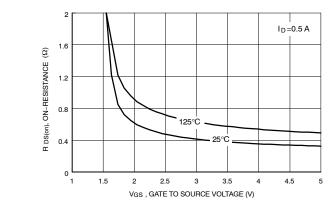


Figure 4. On Resistance Variation with Gate-To- Source Voltage

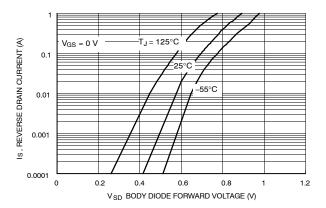
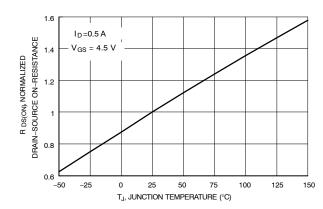


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature





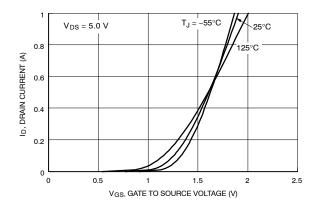


Figure 5. Transfer Characteristics

#### TYPICAL CHARACTERISTICS T<sub>J</sub> = 25°C Unless Otherwise Noted (continued)

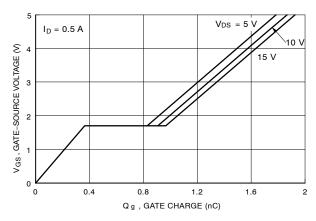


Figure 7. Gate Charge Characteristics

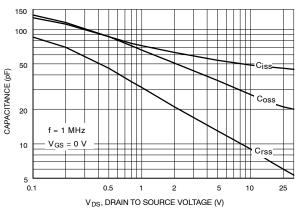


Figure 8. Capacitance Characteristics

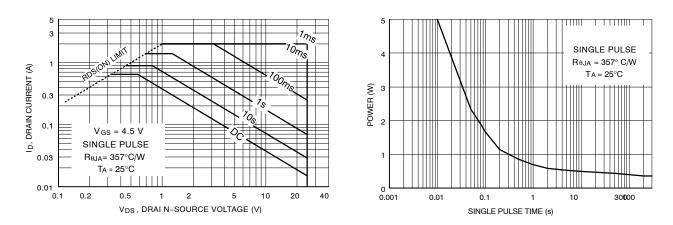




Figure 10. Single Pulse Maximum Power Dissipation

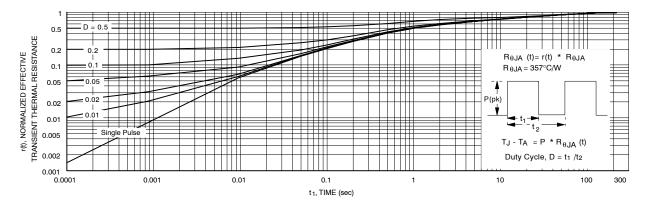


Figure 11. Transient Thermal Response Curve





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